

Dalian Good Display Co., Ltd

LCD Module Specification

Customer	:	
Part Name	:	LCD MODULE
Model NO.	:	YM19264D
Drawing NO.	:	
Approved by	:	
Date	:	2003. 10. 23

Approved by	Checked by	Prepared by	Sheet code
		RD-SJ4	

Add.: No.17, Gonghua Street, Shahekou District, Dalian, China.

Tel.: 86-411-84619565 Fax:86-411-84619585

Website: www.good-lcd.com

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1. Scope

This manual defines general provisions as well as inspection standards for standard LCD module supplied by Dalian Good Display Co., Ltd.

If the event of unforeseen problem or unspecified items may occur, please contact the nearest supplier or our company.

2. Warranty

If module is not stored or used as specified in this manual, it will be void the 12-month warranty.

3. Features

3-1. Features

STN LCD

Display color: Display dot: dark blue

Background: Yellow green

Display format: $192(w) \times 64$ (h) full dots

Input data: 8-bit parallel data interface from a MPU

Multiplexing ratio: 1/64 Duty
Viewing direction: 6 O'clock
Back light: LED

Build-in DC/DC converter circuits

3-2. Mechanical features

Item	Specification	Unit
Outline	120 0(M) × 62 0/H) × 12 0 Mov /T)	mm
dimensions	120.0(W)×62.0(H) ×13.0 Max.(T)	mm
Number of dots	192(W) ×64(H) Dots	_
Viewing area	104.0(W)×39.0(H)	mm
Image area	97.486(W)×32.462(H)	mm
Dot pitch	0.508(W)×0.508(H)	mm
Dot size	0.458(W)×0.458(H)	mm
Weight	Арргох.	g

3-3. Absolute maximum ratings

Ite	em	Symbol	Min.	Max.	Unit	Note
Supply	Supply Logic		0	6.0	V	
Voltage	LCD drive	Vdd – Vee	0	16.0	V	
Input Voltage		Vi	0	Vdd	V	
Operating Ten	nperature	Тор	0	50	$^{\circ}\!\mathbb{C}$	
Storage Temp	erature	Tstg	-20	60	$^{\circ}\mathbb{C}$	
Humidity		_	1	90	%RH	

3-4. Electrical Characteristics

3-4-1 Electrical Characteristics

Iter	n	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply	Logic	Vdd		4.5	5.0	5.5	
Voltage	LCD drive	Vdd-Vee		12.0	1	13.0	V
lanut \/altaaa	"H" Level	Vih	Vdd=5V \pm 5%	0.8Vdd	1	Vdd	V
Supply Voltage Input Voltage Frame Freque Current Consumption	"L" Level	Vil		0	1	0.2Vdd	
Frame Frequer	ncy	Fflm	Vdd=5V	70	75	80	Hz
Current	Logic	ldd	Vdd=5V Vdd-Vee= 15.0V	_		2.8	mΛ
Consumption	LCD drive	lee	Fflm=75Hz	_	0.15	0.2	mA
			Ta= 0 $^{\circ}$ C Φ =0 $^{\circ}$, θ =0 $^{\circ}$	_	13.0	13.5	
LCD Driving (Recommend		Vdd-Vee	Ta= 25°C Φ=0°, θ=0°	12.0	12.5	13.0	V
			Ta= 50°C Φ=0°, θ=0°	11.5	12.0	_	

Note: <1> Duty =1/64 <2> All dots on static state

3-4-2. Back light specifications for LED

(The users can select the modules with or without backlight according to their own needs.)

ltem	Unit	Sta	andard val	ues	Conditions			
nem	Offic	Min.	Тур.	Max.	Cortallions			
Power supply	V	4.0	4.2	5.2	If=270mA			
Luminance	cd/m ² (nit)	213	355	_	If=270mA			
Forward current	mA	<u> </u>		800	_			
Life time	Hrs		20000		Note <1>			
Luminous color	_	Yellow-green			_			
Operating temperature	$^{\circ}\!\mathbb{C}$	-30 ~ 70			-30 ~ 70			_
Storage temperature		-40 ~80		_				

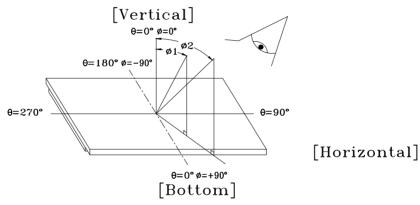
Note<1>: Half value of initial brightness at 20° C 60%RH

3-5. Electro-optical Characteristics

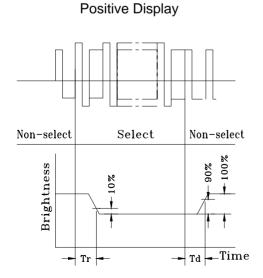
Ite	em	Symbol	Temp.	Conditions	Min.	Тур.	Max.	Unit	Note
LCD Debut		V _{OP}	0℃		_	13.0	13.5		
	LCD Driving Voltage (Recommended voltage)		25 ℃	$\Phi = 0^{\circ}$, $\theta = 0^{\circ}$	12.0	12.5	13.0	V	1,2,5
(Recommen	ided voltage)	(VDD-VO)	50℃		11.5	12.0		1	
Daamanaa	Rise Time	4	0℃		_	1500	2000	Ms	
Response Time		tr	25 ℃	$\Phi = 0^{\circ}$, $\theta = 0^{\circ}$		150	200		1,3,5
	D Ti	td	0℃		_	3000	3500		
	Decay Time		25 ℃		_	200	250		
		Δφ		Vertical	-35	_	35		
Viewin	Viewing angle		25℃	Horizontal	-30	_	30	deg.	1,4,5
Contra	st Ratio	K	25 ℃	$\Phi = 0^{\circ}$, $\theta = 0^{\circ}$	2.0	5.0	_	_	1,5,6

Note: <1> Definition of Φ and θ

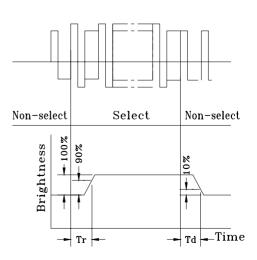
<2> Contrast ratio higher than 2 ($k \ge 2$) can be obtained in this voltage range.



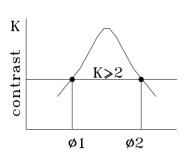
Note: <3>Definition of response time waveform



Negative Display

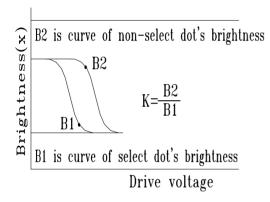


Note: <4>Definition of viewing angle $(\Delta \Phi) \Delta \Phi = |\Phi - \Phi |$

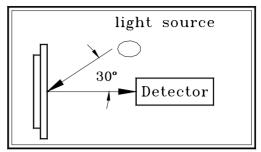


Viewing angle

Note: <6> Definition of Contrast Ratio (K)
Positive Display

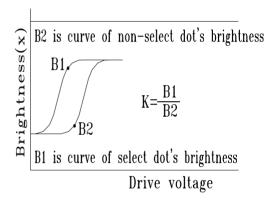


Note: <5> Optical measuring system temperature-regulated chamber



Measuring equipment: DMS (Made in AUTRONIC)

Negative Display



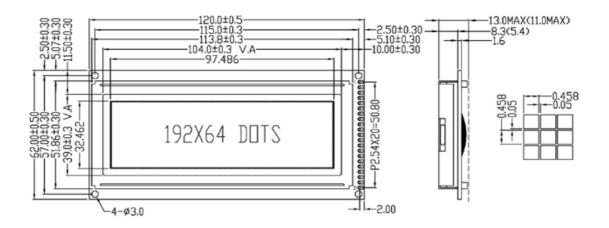
Positive display Contrast (K)=

Brightness of non-selected dot (B2)
Brightness of selected dot (B1)

Negative display Contrast (K)=

Brightness of non-selected dot (B1)
Brightness of selected dot (B2)

4. Dimensional outline



1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21
22V	VDD	V0	Vout	RS	R/W	Ε	D0	D1	DS	D3	D4	D5	D6	D7	/CS1	\css	\C23	RES	Α	К

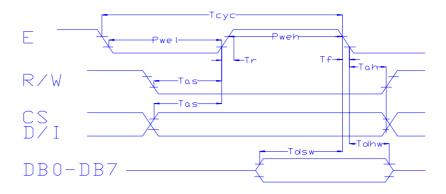
5. I/O terminal

5-1. I/O terminal table

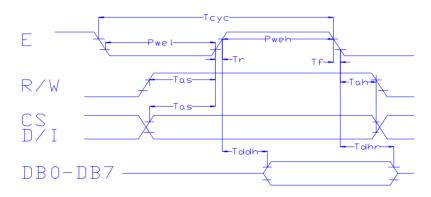
Pin No.	Pin name	Level	Functions							
1	VSS		Ground (0V)							
2	VDD		Power supply for logic circuit:+5V							
3	V0	-	Operating voltage for LCD driving							
4	VOUT	1	Negative voltage output							
5	RS(D/I)	H/L	When RS= "H", it indicates that DB7~DB0 is display data;							
			When RS= "L", it indicates that DB7~DB0 is instruction data.							
6	R/W	H/L	While R/W="H" and E="H", data is read to DB7~DB0							
			While R/W="L" and E="H->L", data is written to DB7~DB0							
7	E	$H.H \rightarrow L$	Enable signal.							
			While R/W="L", data of DB7~DB0 is latched at falling edge of E							
			While R/W="H" and E="H", data of DD RAM appears at DB7~DB0							
8~15	DB0~DB7	H/L	Data bus line.							
16	/CS1	H/L	Chip selection. Selects the chip that controls the left half							
			screen.(active at low level)							
17	/CS2	H/L	Chip selection. Selects the chip that controls the middle half							
			screen.(active at low level)							
18	/CS3	H/L	Chip selection. Selects the chip that controls the right half							
			screen.(active at low level)							
19	/RST	H/L	Controller reset at low level							
20	LED+		Anode of LED Backlight (+5.0V)							
21	LED-		Cathode of LED Backlight							

5-2. Timing and timing diagram

5-2-1. Timing diagram for write operation



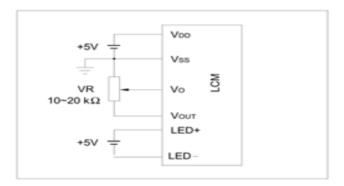
5-2-2. Timing diagram for read operation



5-2-3. Timing characteristics

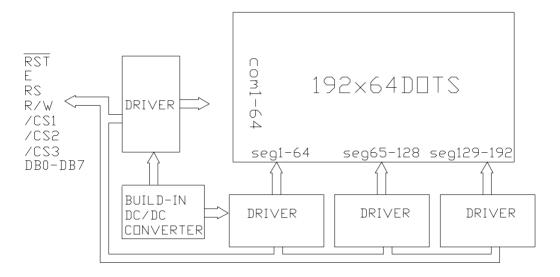
Name	Symbol	Min.	Тур.	Max.	Unit
E cycle	Tcyc	1000	-	-	ns
E High Level Width	Pweh	450	-	-	ns
E Low Level Width	Pwel	450	-	-	ns
E rise time	Tr	-	-	25	ns
E fall time	Tf	-	-	25	ns
Address setup time	Tas	140	-	-	ns
Address hold time	Tah	10	-	-	ns
Data set-up time	Tdsw	200	-	-	ns
Data delay time	Tddr	-	-	320	ns
Write data hold time	Tdhw	10	-	-	ns
Read data hold time	Tdhr	20	-	-	ns

5-3. Power supply connection diagram



5-4. Logic block diagram

The LCD module needs power sources: Vdd for logic



Note: It is necessary to guard all signals from external noise as signal lines are directly connected to C-MOS and are not pull-up or pull-down internally.

5-5. Description for software and hardware

5-5-1. The internal structure of module

From the above diagram, we may find that the module is mainly composed of LCD panel, controllers and segment drivers.

The control circuit mainly consists of Instruction Register (IR), Data Register (DR), Busy Flag (BF), Display On/Off flip-flop (DFF) and XY Counter.

Instruction Register (IR)

IR stores instruction code. When D/I=0, the instruction is written into IR on the falling edge of E.

Data Register (DR)

DR stores data. When DR=1, graphic display data are written into DR or are read into DB7 to DB0 data buses under the action of E. The data transfer between DR and DDRAM are executed by internal operation automatically.

Busy Flag (BF)

Busy flag indicates that the module is operating or not operating. When BF=1, the module is in the internal operation and does not receive any external instruction and data. When BF=0, the module is in the ready status and can accept the data or instruction at any time.

Display on/off flip-flop (DFF)

The display on/off flip-flop makes on/off the liquid crystal display. When DFF=1, display on. The contents of DDRAM are on the screen. When DFF=0, display off.

XY address counter

XY address counter is a 9-bit counter. X address counter is higher 3 bits. Y address counter is lower 6 bits. In fact, XY address counter is used as the address pointer of DDRAM. X address counter is page address pointer of DDRAM. Y address counter is Y address pointer of DDRAM.

Display Data RAM (DDRAM)

DDRAM stores a display data for liquid crystal display. To express on state dot matrix of liquid crystal display, write data 1. The other way, off state writes 0. (See also DDRAM Address Table for the relation between the DDRAM address and the display position)

Z Address Counter

Z address counter is a 6-bit counter. It has cycle-count function, which is used to display with synchronous column scanning. When one column scanning is completed, the address counter is increased by 1 automatically and points to the next column scanning data. After reset, Z address counter is 0.

Z address counter can be preset by DISPLAY START LINE instruction. Therefore, the display start line is controlled by this instruction. That is to say, where the DDRAM data start is the first line on the screen. There are 64 lines in DDRAM, which can be cycle-displayed on the screen.

5-5-2 Control instructions

Display ON/OFF

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	1	1	1	1	1	D

D=1 DISPLAY ON

D=0 DISPLAY OFF. Internal status and display RAM data is not affected.

When the value of D is changed from 0 into 1, the former display is on the screen.

2. Display Start Line

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	1	A5	A4	A3	A2	A1	A0

As explained above in Z address counter, the display start line is controlled by Z address counter. A5~A0 are automatically put into Z address counter. The address of start line can be any line of line 0 to line 63.

For example:

A5~A0 is selected 62, and the correspondence of the first line and DDRAM column is as follows:

DD RAM Column: 62 63 0 1 2 3 60 61 Display column on the screen: 1 2 3 4 5 6 63 64

3. Set Page (X ADDRESS)

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	0	1	1	1	A2	A1	A0

Page address is line address of DDRAM. There are 8 lines in one page. There are 64 lines in DDRAM (8 pages). A2~A0 represent page 0 to page 7.

Read/write data does not affect page address. Page address is changed by this instruction or RST signal. After reset, page address is 0.

See also the address table for correspondence of page address and DDRAM.

4. Set Y Address

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	1	A5	A4	A3	A2	A1	A0

The function of this instruction is to send A5~A0 to Y address counter. They are used as Y address pointer of DDRAM. Y address pointer is automatically incremented by 1 and points to the next unit of DDRAM after write/read is made to DDRAM.

Table 4-4

DDRAM Address Table

	/CS1	=0, /CS2=1,/CS	S3=1	/CS1=	1, /'CS2=0,/CS	3=1	/CS1=	1, /'CS2=1,/	CS3=0	
Y=	0	_	3	0	-	63	0	-	63	Line No.
	DB0		DB0	DB0		DB0	DB0		DB0	0
X=0	\downarrow		\downarrow	\downarrow		\downarrow	\downarrow		\downarrow	\downarrow
	DB7		DB7	DB7		DB7	DB7		DB7	7
	DB0		DB0	DB0		DB0	DB0		DB0	8
\downarrow	\downarrow		\downarrow	\downarrow		\downarrow	\downarrow		\downarrow	\downarrow
	DB7		DB7	DB7		DB7	DB7		DB7	55
	DB0		DB0	DB0		DB0	DB0		DB0	56
X=7	\downarrow		\downarrow	\downarrow		\downarrow	\downarrow		\downarrow	\downarrow
	DB7		DB7	DB7		DB7	DB7		DB7	63

5. STATUS READ

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	0	BF	0	ON/OFF	RST	0	0	0	0

When R/W=1 and D/I=0, status read is output into the corresponding bits of data buses (DB7~DB0) (E in "H" level).

BF: (See also BF part)

ON/OFF: It means the status of Display On/Off flip-flop (See also Display On/Off

flip-flop part)

RST: When RST=1, it indicates that the system are in the initialization and any instruction and data except status read may not be accepted.

6. Write Display Data

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	1	D7	D6	D5	D4	D3	D2	D1	D0

D7-D0 is display data. This instruction writes 8-bit data (D7-D0) into D7-D0 to the corresponding units of DDRAM. The Y address is incremented by 1 automatically.

7. Read Display Data

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	1	D7	D6	D5	D4	D3	D2	D1	D0

Reads out 8-bit data (D7~D0) from the DD RAM. Then Y address is increased by 1 automatically.

The instruction reads out the contents of DDRAM (D7-D0) to the data buses D7-D0.

The Y address is incremented by 1 automatically

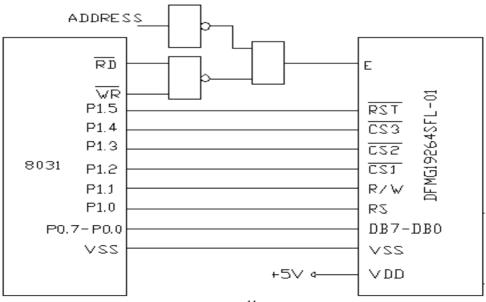
Note: After the setting of DDRAM address, the dummy read is made at the time of reading data.

5-5-3 Method of interfacing module to MPU

The interface circuit is as follows:

The data bus P0 of 8031 is directly connected to the data bus of module. RD and WR of 8031 act as read/write control signal, interfaced to E signal terminal of module by NAND gate.

5-5-4. Application Example



The following is to explain some instructions using the above circuit application.

R0 (indirect address register)

ID (instruction code)

DATA (display data)

1. DISPLAY ON/OFF

CLR P1

SETB CS2

SETB CS3

SETB RST

CLR CS1

MOV A,#ID

MOVX @R0,A

; the left 64 columns

 \downarrow

SETB CS1

SETB CS2

CLR CS3

MOV A,#ID

MOVX @ R0,A ; the right 64 columns

2. READ STATUS

CLR P1

SETB RST

SETB CS2

SETB CS3

CLR CS1

SETB R/W

MOVX A,@R0

;Status is read to A.

3. WRITE DISPLAY DATA)

Assuming that the addresses of X and Y has been set

CLR P1

SETB RST

SETB CS2

SETB CS3

CLR CS1

SETB D/I

MOV A, # DATA

MOVX @R0,A ;Data is written into the corresponding units of

DDRAM

6. Quality level

6-1 Inspection conditions

6-1-1The environmental conditions for inspection shall be as follows:

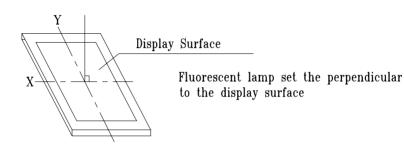
Room temperature: $20\pm3^{\circ}$ C

Humidity: $65\pm20\%$ RH

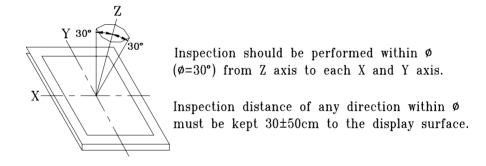
6-1-2 The external visual inspection:

The inspection shall be performed by using a 20W fluorescent lamp for illumination and the distance between LCD and the eyes of the inspector should be at least 30cm.

6-1-3 (1) Light method



(2) Inspection distance and angle



6-2 Sampling procedures for each item's acceptance level table

Defect type	Sampling procedure	AQL
	MIL-STD-105D Inspection Level I	
Major defect	Normal inspection	Q/GD-01-98(II)
	Single sample inspection	
	MIL-STD-105D Inspection Level I	
Minor defect	Normal inspection	Q/GD-01-98(II)
	Single sample inspection	

6-3 Classification of defects

6-3-1 Major defect

A major defect refers to a defect that may substantially degrade usability for product applications.

6-3-2 Minor defect

A minor defect refers to a defect that deviates from existing standards almost unrelated to the effective use of the product or its operation.

6-4 Inspection standards

Item	Criterion for defects	Defect type		
1) Display on inspection	(1) Non display(2) Vertical line is deficient(3) Horizontal line is deficient(4) Cross line is deficient	Major		
2) Black / White spot	$ \begin{array}{ c c c c }\hline Size & \Phi (mm) & Acceptable number \\ \hline & \Phi \leqslant 0.3 & Ignore (note) \\ & 0.3 < \Phi \leqslant 0.45 & 3 \\ & 0.45 < \Phi \leqslant 0.6 & 1 \\ & 0.3 < \Phi & 0 \\ \hline \hline & (Note) Not allowed if four more spots crowd together \\ \hline \end{array} $	Minor		
3) Black / White line	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	Minor		
4) Display pattern	Defects separate with each other at an interval of more than 20mm.			

		User's Manua			Defect		
Item		Crite	rion for defects		type		
		Size ⊕(mm)	Acceptable Number				
		Φ≤0.7	Ignore (note)				
		0.7<Ф≤1.0	3				
5) Spot-like contrast		1.0<Ф≤1.5	1		Minor		
irregularity		1.5<Ф	0				
	Note:	1) Conformed to limit s	amples.				
		2) Intervals of defects a	re more than 30mm.				
		Size ⊕(mm)	Acceptable Numbe	r			
		Ф ≤ 0.4	Ignore (note)				
6) Bubbles in polarizer		0.4<Ф≤0.65	2		Minor		
		0.65<Ф≤1.2	1				
		1.2<₽	0				
7) Scratches and dent on the	Scrate	ches and dent on the p	olarizer shall be in the ac	cordance with	Minor		
polarizer	"2) Black/white spot", and "3) Black/White line".						
8) Stains on the surface of) Stains on the surface of Stains which cannot be removed even when wiped lightly				Minor		
LCD panel	with a	soft cloth or similar cle	aning.		IVIII IOI		
9) Rainbow color	No ra	inbow color is allowed	in the optimum contrast of	on state within	Minor		
9) Rainbow color	the active area.						
10) Viewing area	Polari	zer edge or line is visi	ole in the opening viewin	g area due to	Minor		
encroachment	polari	zer shortness or sealing	g line.		IVIII IOI		
11) Bezel appearance	Rust a	and deep damages that	are visible in the bezel a	re rejected.	Minor		
12) Defect of land surface	Evident crevices that are visible are rejected.						
contact	Evident crevices that are visible are rejected.						
	(1) F	ailure to mount parts					
13) Parts mounting	(2) F	Parts not in the specification	ations are mounted		Major		
	(3) F	or example: Polarity is	reversed, HSC or TCP fa	lls off.			
14) Part alignment	(1) L	SI, IC lead width is mo	re than 50% beyond pad	outline.	Minor		
14) I alt allgrillerit	(2) N	More than 50% of LSI, I	C leads is off the pad outl	ine.	IVIII IOI		
	(1)).45<Ф, N ≥ 1			Major		
15) Conductive foreign	(2)	0.3<Φ≤0.45, N≥1			Minor		
matter (solder ball,	(D: Average diameter of	solder ball (unit: mm)				
solder hips)	(3)).5 <l, n≥1<="" td=""><td></td><td></td><td>Minor</td></l,>			Minor		
		L: Average length of so	lder chip (unit: mm)				
	(1) [Deep damage is found	on copper foil and the pa	ttern is nearly	Major		
16) PCB pattern damage	t	oroken.					
	(2)	Damage on copper foil of	other than 1) above		Minor		
	(1) [Due to PCB copper	foil pattern burnout, the	ne pattern is			
	d	connected, using a jum	oer wire for repair;2 or mo	ore places are			
17) Faulty PCB correction	c	corrected per PCB.			Minor		
	(2)	Short-circuited part is	cut, and no resist coat	ing has been			
	ŗ	erformed.					

Item	Criterion for defects	
18) Bezel flaw Bezel claw missing or not bent		
	(1) Failure to stamp or label error, or not legible.(all acceptable if	Minor
19) Indication on name plate	legible)	Minor
(sampling indication label)	(2) The separation is more than 1/3 for indication discoloration, in	IVIIIIOI
	which the characters can be checked.	

7. Reliability

7-1 Lifetime

50,000 hours (25℃ in the room without ray of sun)

7-2 Items of reliability

	Item	Condition	Criterion				
	High Temperature Operating	50℃ 96hrs	No cosmetic failure is allowable. Contrast ratio should be between initial				
2)	Low Temperature Operation	-10℃ 96hrs	value ±10%. Total current consumption should be below double of initial value.				
3)	Humidity	40 °c, 90%RH, 96hrs					
4)	High Temperature	60 ් 96hrs	No cosmetic failure is allowable.				
5)	Low Temperature	-20℃ 96hrs	Contrast ratio should be between initial value $\pm 20\%$. Total current consumption should be below				
6)	Thermal shock	25℃→30℃→25℃→60℃ 5(min) 30(min) 5(min) 30(min) 5 cycle, 55~60%RH	double of initial value.				
7)	Vibration	10~55~10hz amplitude: 1.5mm 2hrs for each direction (X,Y,Z)	No defects in cosmetic and operational function are allowable. Total current consumption should be below double of initial value.				

8. Handling precautions

8-1 Mounting method

A panel of LCD module made by Dalian Good Display Co., Ltd. consists of two thin glass plates with polarizers that easily get damaged.

And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board (PCB), extreme care should be used when handling the LCD modules.

8-2 Cautions of LCD handling and cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below)

	and wipe lightly.	
		Isopropyl alcohol
		Ethyl alcohol
		Trichlorotriflorothane
	Do	not wipe the display surface with dry or hard materials that will damage the
	pola	arizer surface.
	Do not use the following solvent:	
		Water
		Ketene
		Aromatics
8-3 Caution against static charge		
The LCD weedule use C MOC LCI drivers Course recommend your		

The LCD module use C-MOS LSI drivers. So we recommend you:

Connect any unused input terminal to V_{dd} or V_{ss} . Do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

8-4 Packaging

- Module employs LCD elements, and must be treated as such.
 Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

8-5 Caution for operation

- It is an indispensable condition to drive LCD module within the limits of the specified voltage since the higher voltage over the limits may cause the shorter life of LCD module.
 - An electrochemical reaction due to DC (direct current) causes LCD undesirable deterioration so that the uses of DC (direct current) drive should be avoided.
- Response time will be extremely delayed at lower temperature than the
 operating temperature range and on the other hand at higher temperature LCD
 module may show dark color in them. However those phenomena do not mean
 malfunction or out of order of LCD module, which will come back in the specified
 operating temperature.

8-6 Storage

In the case of storing for a long period of time, the following ways are recommended:

- Storage in polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with not desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping the storage temperature range.
- Storing with no touch on polarizer surface by any thing else.

8-7 Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and to wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well at once with soap and water.

9. Precaution for use

- 9-1 Both parties should provide a limit sample on an occasion when both parties agree its necessity.
 - The judgement by a limit sample shall take effect after the limit sample has been established and confirmed by both parties
- 9-2 On the following occasions, the handling of problem should be decided through discussion and agreement between responsible of the both parties.
 - When a question is arisen in this manual.
 - When a new problem is arisen which is not specified in this manual.
 - Some problem is arisen due to the change of inspection and operating conditions in users.
 - When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.